

# DAY TWO - WEDNESDAY APRIL 16



**8:00 AM** Continental Breakfast in the Hotel Lobby

**9:00 AM** Opening Remarks in the Sierra Ballroom

**9:10 AM** **Interconnect & Testing Panel - moderated by Tom Issenhuth, OIF MA&E Chair, Huawei Technologies**  
Matt Traverso, Marvell  
Toshiyasu Ito, Yamaichi Electronics  
Paul Brooks, VIAVI Solutions

**10:10 AM** **Keynote - Ashwin Gumaste, Microsoft**

**10:50 AM** Coffee Break

**11:20 AM** **Optical Modulation Panel - moderated by Scott Wilkinson, Lead Analyst, Networking Components, Signal AI**  
Balazs Matuz, Huawei Technologies Co., Ltd.  
Massimo Sorbara, Global Foundries

**12:20 PM** Buffet Lunch

**1:20 PM** **Electrical Modulation Panel - moderated by Scott Wilkinson, Lead Analyst, Networking Components, Signal AI**  
Naim Ben-Hamida, Ciena  
Curtis Ling, MaxLinear  
Peter Graumann, Microchip  
David Stauffer, Kandou Bus  
Adam Healey, Broadcom Inc.

**2:55 PM** Coffee Break

**3:25 PM** **Keynote - Sara Zebian, OpenAI**

**4:00 PM** **Q&A with Keynote Speakers - moderated by Nathan Tracy, OIF President, TE Connectivity**  
Ashwin Gumaste, Microsoft  
Tad Hofmeister, Google  
Xu Wang, Meta Platforms  
Sara Zebian, OpenAI

**4:35 PM** Closing Remarks